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REVISION HISTORY

6/2016-Rev. B to Rev. C

Changes to Analog Inputs Parameter, Table 7 8
Added Digital Inputs Parameter, Table 7 8

4/2016—Rev. A to Rev. B

Changed CP-32-2 to CP-32-7	Throughout
Changed LFCSP_VQ to LFCSP	Throughout
Changes to Figure 4 and Table 9	9
Changes to Figure 6 and Table 10	
Updated Outline Dimensions	
Changes to Ordering Guide	

3/2009—Rev. 0 to Rev. A

Change to IDD Parameter, Table 2	4
Change to IDD Parameter, Table 3	
Changes to Figure 16	14

8/2008—Revision 0: Initial Version

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SPECIFICATIONS

±15 V DUAL SUPPLY

 V_{DD} = +15 V \pm 10%, V_{SS} = –15 V \pm 10%, GND = 0 V, unless otherwise noted.1

Table 2.

Parameter	+25°C	-40°C to +85°C	-40°C to +125°C ¹	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{SS} to V_{DD}	V	
On Resistance (R _{ON})	9.5			Ωtyp	$V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V}, V_S = \pm 10 \text{ V},$
	11.5	14	16	Ωmax	$I_s = -10 \text{ mA}$; see Figure 27
On-Resistance Match Between Channels (ΔR _{ON})	0.55			Ω typ	$V_{\text{DD}} = +13.5 \text{ V}, V_{\text{SS}} = -13.5 \text{ V}, V_{\text{S}} = \pm 10 \text{ V}, \\ I_{\text{S}} = -10 \text{ mA}$
	1	1.5	1.7	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	1.6			Ωtyp	$V_{DD} = +13.5 \text{ V}, V_{SS} = -13.5 \text{ V}, V_S = \pm 10 \text{ V},$ $I_S = -10 \text{ mA}$
	1.9	2.15	2.3	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +16.5 V, V_{SS} = -16.5 V$
Source Off Leakage, Is (Off)	±0.01			nA typ	$V_s = \pm 10 V$, $V_D = \mp 10 V$; see Figure 28
	±0.25	±1	±4	nA max	
Drain Off Leakage, I _D (Off)	±0.01			nA typ	$V_{s} = \pm 10 V$, $V_{D} = \mp 10 V$; see Figure 28
	±0.5	±3	±20	nA max	
Channel On Leakage, I _D , I _S (On)	±0.05			nA typ	$V_s = V_D = \pm 10 V$; see Figure 29
	±0.5	±3	±20	nA max	
DIGITAL INPUTS		-			
Input High Voltage, VINH			2.0	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current	±0.002			µA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
mpar cancin	_0.001		±0.1	μA max	
Digital Input Capacitance, C _{IN}	3			pF typ	
DYNAMIC CHARACTERISTICS ²	-			P. 91	
Transition Time, transition	105			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	160	200	225	ns max	$V_s = 10 V$, see Figure 30
Break-Before-Make Time Delay, t	40			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
			10	ns min	$V_{s1} = V_{s2} = 10 V$; see Figure 31
t _{on} (EN)	83			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	110	140	155	ns max	$V_s = 10 V$; see Figure 32
t _{OFF} (EN)	98			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	120	145	165	ns max	$V_s = 10 V$; see Figure 32
Charge Injection	10			pC typ	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 33
Off Isolation	-73			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 34
Channel-to-Channel Crosstalk	-70			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 35
Total Harmonic Distortion Plus Noise (THD + N)	0.07			% typ	$R_L = 110 \Omega$, 15 V p-p, f = 20 Hz to 20 kHz; see Figure 37
–3 dB Bandwidth					$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 36
ADG1406	60			MHz typ	··· , ·· · · , ··· · · · · · · · · · ·
ADG1407	110			MHz typ	
Insertion Loss	0.6			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 36
C _s (Off)	8			pF typ	f = 1 MHz
$C_{\rm D}$ (Off)	-			F 7 P	f = 1 MHz
ADG1406	90			pF typ	
ADG1407	45	1		pF typ	

Parameter	+25°C	-40°C to +85°C	-40°C to +125°C ¹	Unit	Test Conditions/Comments
C _D , C _s (On)					f = 1 MHz
ADG1406	115			pF typ	
ADG1407	70			pF typ	
POWER REQUIREMENTS					$V_{DD} = +16.5 V$, $V_{SS} = -16.5 V$
I _{DD}	0.002			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$
			1	μA max	
I _{DD}	280			μA typ	Digital inputs = 5 V
			475	μA max	
I _{ss}	0.002			μA typ	Digital inputs = $0 V$, $5 V$ or V_{DD}
			1	μA max	
V _{DD} /V _{SS}			±4.5/±16.5	V min/max	

 1 Temperature range for B version is -40° C to $+125^\circ$ C. 2 Guaranteed by design, not subject to production test.

12 V SINGLE SUPPLY

 V_{DD} = 12 V ± 10%, V_{SS} = 0 V, GND = 0 V, unless otherwise noted.

Parameter	+25°C	-40°C to +85°C	-40°C to +125°C ¹	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 to V _{DD}	V	
On Resistance (R _{ON})	18			Ωtyp	$V_{DD} = 10.8 V$, $V_{SS} = 0 V$; $V_S = 0 V$ to 10 V, $I_S = -10 mA$; see Figure 27
	21.5	26	28.5	Ωmax	
On-Resistance Match Between Channels (ΔR_{ON})	0.55			Ωtyp	$V_{DD} = 10.8 V, V_{SS} = 0 V; V_S = 0 V to 10 V,$ $I_S = -10 mA$
	1.2	1.6	1.8	Ωmax	
On-Resistance Flatness ($R_{FLAT(ON)}$)	5			Ωtyp	$V_{DD} = 10.8 V, V_{SS} = 0 V; V_S = 0 V to 10 V,$ $I_S = -10 mA$
	6	6.9	7.3	Ωmax	
LEAKAGE CURRENTS					$V_{\text{DD}} = 10.8 \text{ V}$
Source Off Leakage, Is (Off)	±0.01			nA typ	$V_s = 1 V/10 V$, $V_D = 10 V/1 V$; see Figure 28
	±0.25	±1	±4	nA max	
Drain Off Leakage, I_D (Off)	±0.01			nA typ	$V_s = 1 \text{ V}/10 \text{ V}, V_D = 10 \text{ V}/1 \text{ V}; \text{ see}$ Figure 28
	±0.5	±3	±20	nA max	
Channel On Leakage, I _D , I _S (On)	±0.01			nA typ	$V_s = V_D = 1 V \text{ or } 10 V$; see Figure 29
	±0.5	±3	±20	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.0	V min	
Input Low Voltage, VINL			0.8	V max	
Input Current	±0.002			μA typ	$V_{\text{IN}} = V_{\text{GND}} \text{ or } V_{\text{DD}}$
			±0.1	μA max	
Digital Input Capacitance, C _{IN}	4			pF typ	
DYNAMIC CHARACTERISTICS ²					
Transition Time, t _{TRANSITION}	170			ns typ	$R_L = 100 \Omega$, $C_L = 35 pF$
	250	310	350	ns max	Vs = 8 V; see Figure 29
Break-Before-Make Time Delay, t_{BBM}	75			ns typ	$R_L = 100 \Omega$, $C_L = 35 pF$
			30	ns min	$V_{s1} = V_{s2} = 8 V$; see Figure 31

Data Sheet

ADG1406/ADG1407

Parameter	+25°C	-40°C to +85°C	-40°C to +125°C ¹	Unit	Test Conditions/Comments
t _{on} (EN)	145			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	205	250	285	ns max	V _s = 8 V; see Figure 31
t _{off} (EN)	112			ns typ	$R_L = 100 \Omega$, $C_L = 35 pF$
	150	175	200	ns max	V _s = 8 V; see Figure 31
Charge Injection	10			pC typ	$V_s = 6 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 33
Off Isolation	-73			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 34
Channel-to-Channel Crosstalk	-70			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 35
–3 dB Bandwidth					$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 36
ADG1406	35			MHz typ	
ADG1407	70			MHz typ	
Insertion Loss	0.6			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 36
C _s (Off)	12			pF typ	f = 1 MHz
C _D (Off)					f = 1 MHz
ADG1406	145			pF typ	
ADG1407	72			pF typ	
C _D , C _S (On)					f = 1 MHz
ADG1406	166			pF typ	
ADG1407	93			pF typ	
POWER REQUIREMENTS					V _{DD} = 13.2 V
I _{DD}	0.002			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$
			1	μA max	
I _{DD}	150			μA typ	Digital inputs = 5 V
			475	μA max	
V _{DD}			5/16.5	V min/max	$V_{SS} = 0 V, GND = 0 V$

 1 Temperature range for B version: –40°C to +125°C. 2 Guaranteed by design, not subject to production test.

±5 V DUAL SUPPLY

 V_{DD} = +5 V \pm 10%, V_{SS} = -5 V \pm 10%, GND = 0 V, unless otherwise noted.

Table 4.

Parameter	+25°C	-40°C to +85°C	-40°C to +125°C ¹	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			Vss to VDD	V	
On Resistance (R _{ON})	21			Ωtyp	$V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}, V_{S} = \pm 4.5 \text{ V},$ $I_{S} = -10 \text{ mA};$ see Figure 27
	25	29	32	Ωmax	
On-Resistance Match Between Channels (ΔR _{ON})	0.6			Ωtyp	$\label{eq:VDD} \begin{split} V_{\text{DD}} &= +4.5 \ \text{V}, \ \text{V}_{\text{SS}} = -4.5 \ \text{V}, \ \text{V}_{\text{S}} = \pm 4.5 \text{V}, \\ I_{\text{S}} &= -10 \ \text{mA} \end{split}$
	1.3	1.7	1.9	Ωmax	
On-Resistance Flatness (R _{FLAT(ON)})	5.2			Ωtyp	$V_{DD} = +4.5 V$, $V_{SS} = -4.5 V$, $V_S = \pm 4.5 V$, $I_S = -10 mA$
	6.4	7.3	7.6	Ωmax	
LEAKAGE CURRENTS					$V_{DD} = +5.5 V, V_{SS} = -5.5 V$
Source Off Leakage, I _s (Off)	±0.01			nA typ	$V_{\text{S}}=\pm4.5$ V, $V_{\text{D}}=\mp4.5$ V; see Figure 28
	±0.25	±1	±4	nA max	
Drain Off Leakage, I _D (Off)	±0.01			nA typ	$V_s = \pm 4.5 \text{ V}, V_D = \mp 4.5 \text{ V}; \text{ see Figure 28}$
	±0.5	±3	±20	nA max	
Channel On Leakage, I _D , I _S (On)	±0.01			nA typ	$V_{s} = V_{D} = \pm 4.5 V$; see Figure 29
-	±0.5	±3	±20	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.0	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current	±0.002			μA typ	$V_{IN} = V_{GND} \text{ or } V_{DD}$
			±0.1	µA max	
Digital Input Capacitance, C _{IN}	3.5			pF typ	
DYNAMIC CHARACTERISTICS ²					
Transition Time, transition	260			ns typ	$R_L = 100 \Omega, C_L = 35 pF$
	435	510	565	ns max	$V_s = 5 V$; see Figure 30
Break-Before-Make Time Delay, tBBM	90			ns typ	$R_L = 100 \ \Omega, \ C_L = 35 \ pF$
			30	ns min	$V_{S1} = V_{S2} = 5 V$; see Figure 31
t _{on} (EN)	230			ns typ	$R_L = 100 \ \Omega, \ C_L = 35 \ pF$
	335	400	445	ns max	$V_s = 5 V$; see Figure 32
t _{off} (EN)	205			ns typ	$R_L = 100 \ \Omega, C_L = 35 \ pF$
	290	340	370	ns max	$V_s = 5 V$; see Figure 32
Charge Injection	10			pC typ	$V_s = 0 V$, $R_s = 0 \Omega$, $C_L = 1 nF$; see Figure 33
Off Isolation	-73			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 34
Channel-to-Channel Crosstalk	-70			dB typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 1 MHz$; see Figure 35
Total Harmonic Distortion, THD + N	0.18			% typ	R_L = 110 $\Omega,$ 5 V p-p, f = 20 Hz to 20 kHz; see Figure 37
–3 dB Bandwidth					$R_L = 50 \Omega$, $C_L = 5 pF$; see Figure 36
ADG1406	40			MHz typ	
ADG1407	80			MHz typ	
Insertion Loss	1.15			dB typ	R_L = 50 $\Omega,$ C_L = 5 pF, f = 1 MHz; see Figure 36
C _s (Off)	10			pF typ	f = 1 MHz
C_D (Off)					f = 1 MHz
ADG1406	123			pF typ	
ADG1407	62			pF typ	
C _D , C _S (On)					f = 1 MHz
ADG1406	148			pF typ	
ADG1407	88		C Page 6 of 20	pF typ	

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Parameter	+25°C	-40°C to +85°C	-40°C to +125°C ¹	Unit	Test Conditions/Comments
POWER REQUIREMENTS					$V_{DD} = +5.5 V, V_{SS} = -5.5 V$
IDD	0.002			μA typ	Digital inputs = $0 V \text{ or } V_{DD}$
			1	μA max	
lss	0.002			μA typ	Digital inputs = $0 V$, $5 V$, or V_{DD}
			1	μA max	
V _{DD} /V _{SS}			±4.5/±16.5	V min/max	

¹ Temperature range for B version: -40° C to $+125^{\circ}$ C.

² Guaranteed by design, not subject to production test.

CONTINUOUS CURRENT PER CHANNEL

Table 5. Continuous Current per Channel (ADG1406)

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT PER CHANNEL ¹					
15 V Dual Supply					$V_{DD} = +13.5 V$, $V_{SS} = -13.5 V$
28-Lead TSSOP	180	100	50	mA max	
32-Lead LFCSP	300	150	60	mA max	
12 V Single Supply					$V_{DD} = 10.8 V, V_{SS} = 0 V$
28-Lead TSSOP	150	90	50	mA max	
32-Lead LFCSP	260	130	55	mA max	
5 V Dual Supply					$V_{DD} = +4.5 V, V_{SS} = -4.5 V$
28-Lead TSSOP	140	85	45	mA max	
32-Lead LFCSP	245	130	55	mA max	

¹ Guaranteed by design, not subject to production test.

Table 6. Continuous Current per Channel (ADG1407)

Parameter	25°C	85°C	125°C	Unit	Test Conditions/Comments
CONTINUOUS CURRENT PER CHANNEL ¹					
15 V Dual Supply					$V_{DD} = +13.5 V, V_{SS} = -13.5 V$
28-Lead TSSOP	135	85	45	mA max	
32-Lead LFCSP	235	125	55	mA max	
12 V Single Supply					$V_{DD} = 10.8 V, V_{SS} = 0 V$
28-Lead TSSOP	110	70	40	mA max	
32-Lead LFCSP	190	110	50	mA max	
5 V Dual Supply					$V_{DD} = +4.5 V, V_{SS} = -4.5 V$
28-Lead TSSOP	105	65	40	mA max	
32-Lead LFCSP	180	100	50	mA max	

¹ Guaranteed by design, not subject to production test.

ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$, unless otherwise noted.

Table 7.

Parameter	Rating
V _{DD} to V _{SS}	35 V
V _{DD} to GND	–0.3 V to +25 V
Vss to GND	+0.3 V to -25 V
Analog Inputs ¹	V _{ss} – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Digital Inputs ¹	GND – 0.3 V to V _{DD} + 0.3 V or 30 mA, whichever occurs first
Continuous Current, Sx or Dx Pins	Table 5 and Table 6 specifications + 15%
Peak Current, Sx or Dx Pins	
(Pulsed at 1 ms, 10% Duty Cycle Maximum)	
28-Lead TSSOP	300 mA
32-Lead LFCSP	550 mA
Operating Temperature Range	
Industrial (B Version)	-40°C to +125°C
Storage Temperature Range	–65°C to +150°C
Junction Temperature	150°C
Reflow Soldering, Pb-Free	
Peak Temperature	260 (+0/–5)°C
Time at Peak Temperature	10 sec to 40 sec

¹ Overvoltages at the Ax, EN, Sx, or Dx pins are clamped by internal diodes. Limit current to the maximum ratings given.

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Only one absolute maximum rating may be applied at any one time.

THERMAL RESISTANCE

 θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 8. Thermal Resistance

Package Type	θ」Α	ον	Unit
28-Lead TSSOP	97.9	14	°C/W
32-Lead LFCSP	27.27		°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

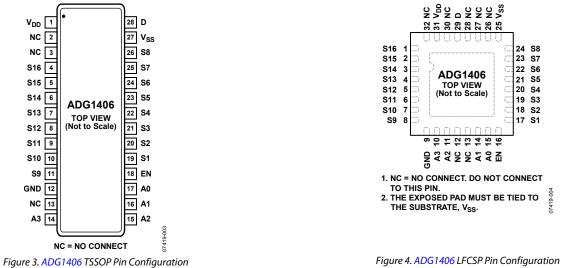
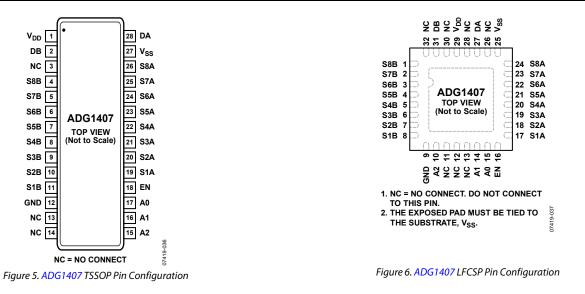


Table 9. ADG1406 Pin Function Descriptions

Pin No.			
TSSOP	LFCSP	Mnemonic	Description
1	31	V _{DD}	Most Positive Power Supply Potential.
2, 3, 13	12, 13, 26, 27, 28, 30, 32	NC	No Connect.
4	1	S16	Source Terminal 16. This pin can be an input or an output.
5	2	S15	Source Terminal 15. This pin can be an input or an output.
6	3	S14	Source Terminal 14. This pin can be an input or an output.
7	4	S13	Source Terminal 13. This pin can be an input or an output.
8	5	S12	Source Terminal 12. This pin can be an input or an output.
9	6	S11	Source Terminal 11. This pin can be an input or an output.
10	7	S10	Source Terminal 10. This pin can be an input or an output.
11	8	S9	Source Terminal 9. This pin can be an input or an output.
12	9	GND	Ground (0 V) Reference.
14	10	A3	Logic Control Input.
15	11	A2	Logic Control Input.
16	14	A1	Logic Control Input.
17	15	A0	Logic Control Input.
18	16	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are turned off. When this pin is high, the Ax logic inputs determine which switch is turned on.
19	17	S1	Source Terminal 1. This pin can be an input or an output.
20	18	S2	Source Terminal 2. This pin can be an input or an output.
21	19	S3	Source Terminal 3. This pin can be an input or an output.
22	20	S4	Source Terminal 4. This pin can be an input or an output.
23	21	S5	Source Terminal 5. This pin can be an input or an output.
24	22	S6	Source Terminal 6. This pin can be an input or an output.
25	23	S7	Source Terminal 7. This pin can be an input or an output.
26	24	S8	Source Terminal 8. This pin can be an input or an output.
27	25	Vss	Most Negative Power Supply Potential. In single-supply applications, this pin can be connected to ground.
28	29	D	Drain Terminal. This pin can be an input or an output.
Not applicable	0	EPAD	Exposed Pad. The exposed pad must be tied to the substrate, Vss.

Table 10. ADG1406 Truth Table

A3	A2	A1	A0	EN	On Switch	
Х	Х	Х	Х	0	None	
0	0	0	0	1	1	
0	0	0	1	1	2	
0	0	1	0	1	3	
0	0	1	1	1	4	
0	1	0	0	1	5	
0	1	0	1	1	6	
0	1	1	0	1	7	
0	1	1	1	1	8	
1	0	0	0	1	9	
1	0	0	1	1	10	
1	0	1	0	1	11	
1	0	1	1	1	12	
1	1	0	0	1	13	
1	1	0	1	1	14	
1	1	1	0	1	15	
1	1	1	1	1	16	





Pin No.					
TSSOP	LFCSP	Mnemonic	Description		
1	29	V _{DD}	Most Positive Power Supply Potential.		
2	31	DB	Drain Terminal B. This pin can be an input or an output.		
3, 13, 14	11, 12, 13, 26, 28, 30, 32	NC	No Connect.		
4	1	S8B	Source Terminal 8B. This pin can be an input or an output.		
5	2	S7B	Source Terminal 7B. This pin can be an input or an output.		
б	3	S6B	Source Terminal 6B. This pin can be an input or an output.		
7	4	S5B	Source Terminal 5B. This pin can be an input or an output.		
8	5	S4B	Source Terminal 4B. This pin can be an input or an output.		
9	6	S3B	Source Terminal 3B. This pin can be an input or an output.		
10	7	S2B	Source Terminal 2B. This pin can be an input or an output.		
11	8	S1B	Source Terminal 1B. This pin can be an input or an output.		
12	9	GND	Ground (0 V) Reference.		
15	10	A2	Logic Control Input.		
16	14	A1	Logic Control Input.		
17	15	A0	Logic Control Input.		
18	16	EN	Active High Digital Input. When this pin is low, the device is disabled and all switches are turned off. When this pin is high, the Ax logic inputs determine which switch is turned on.		
19	17	S1A	Source Terminal 1A. This pin can be an input or an output.		
20	18	S2A	Source Terminal 2A. This pin can be an input or an output.		
21	19	S3A	Source Terminal 3A. This pin can be an input or an output.		
22	20	S4A	Source Terminal 4A. This pin can be an input or an output.		
23	21	S5A	Source Terminal 5A. This pin can be an input or an output.		
24	22	S6A	Source Terminal 6A. This pin can be an input or an output.		
25	23	S7A	Source Terminal 7A. This pin can be an input or an output.		
26	24	58A	Source Terminal 8A. This pin can be an input or an output.		
27	25	Vss	Most Negative Power Supply Potential. In single-supply applications, this pin can be connected to ground.		
28	27	DA	Drain Terminal A. This pin can be an input or an output.		
Not applicable	0	EPAD	Exposed Pad. The exposed pad must be tied to the substrate, Vss.		

Table 12. ADG1407 Truth Table

A2	A1	A0	EN	On Switch Pair	
Х	Х	Х	0	None	
0	0	0	1	1	
0	0	1	1	2	
0	1	0	1	3	
0	1	1	1	4	
1	0	0	1	5	
1	0	1	1	6	
1	1	0	1	7	
1	1	1	1	8	

TYPICAL PERFORMANCE CHARACTERISTICS

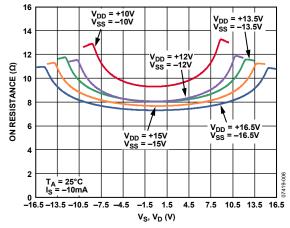


Figure 7. On Resistance as a Function of V_D (V_s), Dual Supply

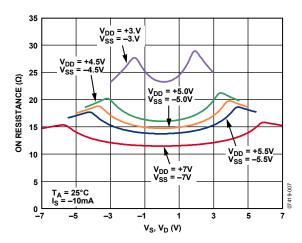


Figure 8. On Resistance as a Function of V_D (Vs), Dual Supply

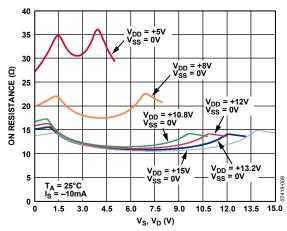


Figure 9. On Resistance as a Function of V_D (V_s), Single Supply

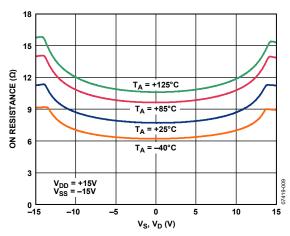


Figure 10. On Resistance as a Function of V_D (V_s) for Different Temperatures, 15 V Dual Supply

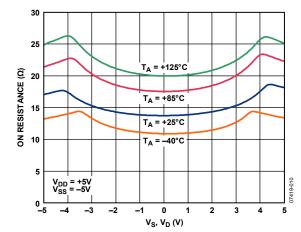


Figure 11. On Resistance as a Function of V_D (V_s) for Different Temperatures, 5 V Dual Supply

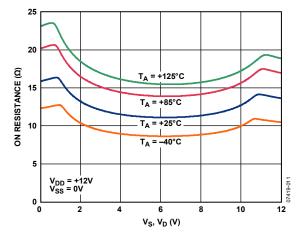


Figure 12. On Resistance as a Function of V_D (V_S) for Different Temperatures, 12 V Single Supply

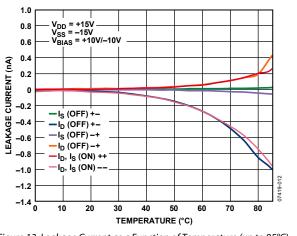
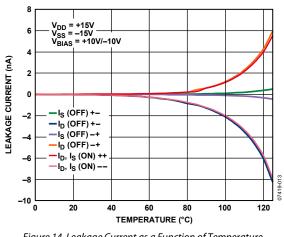
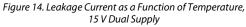
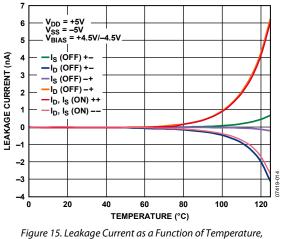


Figure 13. Leakage Current as a Function of Temperature (up to 85°C), 15 V Dual Supply







5 V Dual Supply

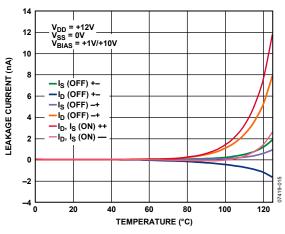
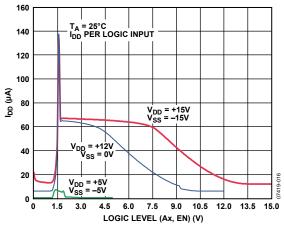
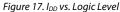


Figure 16. Leakage Current as a Function of Temperature, 12 V Single Supply





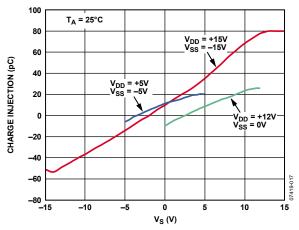
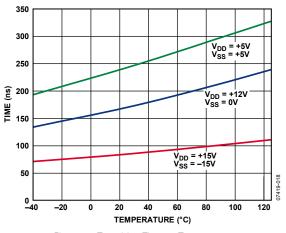
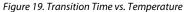
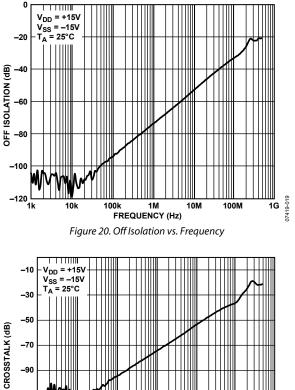


Figure 18. Charge Injection vs. Source Voltage







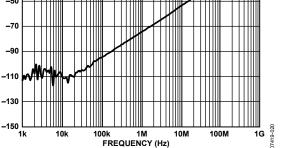
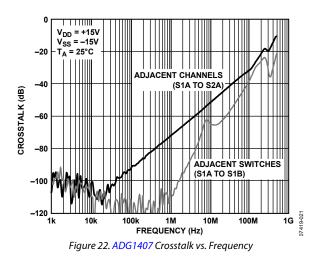
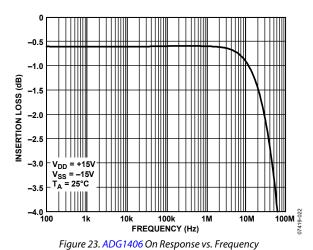


Figure 21. ADG1406 Crosstalk vs. Frequency





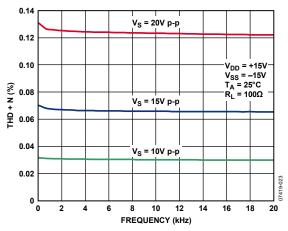


Figure 24. THD + N vs. Frequency, 15 V Dual Supply

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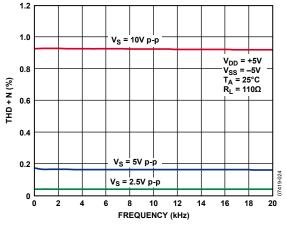
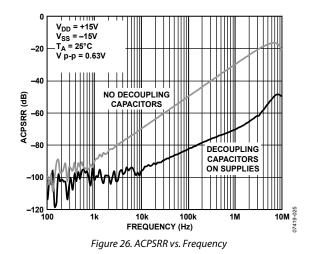


Figure 25. THD + N vs. Frequency, 5 V Dual Supply



TERMINOLOGY

 \mathbf{R}_{ON} Ohmic resistance between the D and S terminals.

 ΔR_{ON} Difference between the R_{ON} of any two channels.

 $\mathbf{R}_{FLAT(ON)}$ Flatness is defined as the difference between the maximum and minimum value of on resistance as measured.

Is (Off) Source leakage current when the switch is off.

I_D (Off) Drain leakage current when the switch is off.

I_D, I_s (On) Channel leakage current when the switch is on.

 $\mathbf{V}_{\mathrm{D}},\mathbf{V}_{S}$ Analog voltage on Terminal D and Terminal S.

Cs (Off) Channel input capacitance for the off condition.

 C_D (Off) Channel output capacitance for the off condition.

C_D, C_s (On) On switch capacitance.

C_{IN} Digital input capacitance.

ton (EN)

Delay time between the 50% and 90% points of the digital input and the switch on condition.

 $t_{\rm OFF}$ (EN) Delay time between the 50% and 90% points of the digital input and the switch off condition.

t_{TRANSITION}

Delay time between the 50% and 90% points of the digital inputs and the switch on condition when switching from one address state to another.

ADG1406/ADG1407

t_{BBM}

Off time measured between the 80% points of the switches when switching from one address state to another.

V_{INL} Maximum input voltage for Logic 0.

 \mathbf{V}_{INH} Minimum input voltage for Logic 1.

I_{INL}, I_{INH} Input current of the digital input.

I_{DD} Positive supply current.

Iss Negative supply current.

Off Isolation A measure of unwanted signal coupling through an off channel.

Charge Injection A measure of the glitch impulse transferred from the digital input to the analog output during switching.

Bandwidth The frequency at which the output is attenuated by 3 dB.

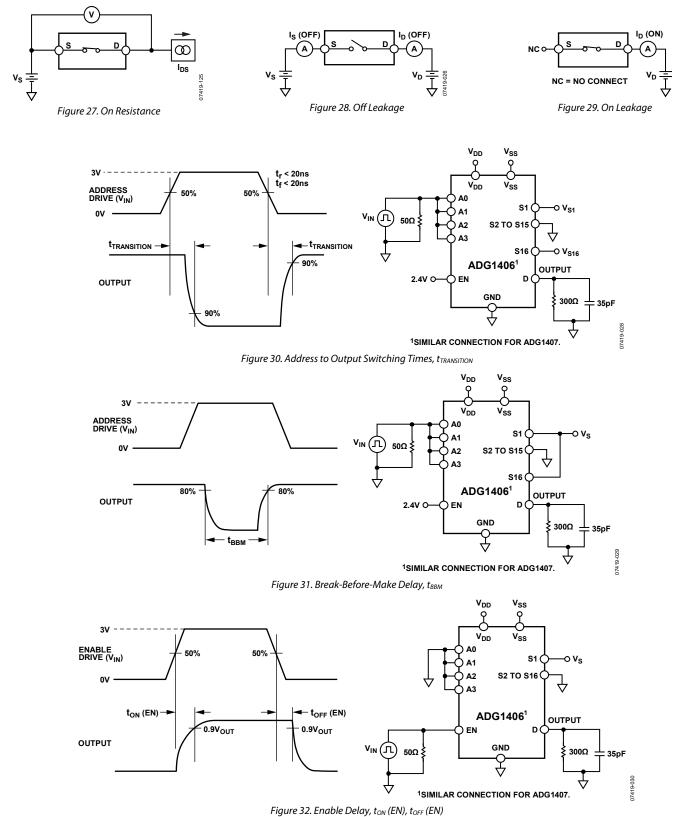
On Response The frequency response of the on switch.

Total Harmonic Distortion Plus Noise (THD + N) The ratio of the harmonic amplitude plus noise of the signal to the fundamental.

AC Power Supply Rejection Ratio (ACPSRR)

Measures the ability of a device to avoid coupling noise and spurious signals that appear on the supply voltage pin to the output of the switch. The dc voltage on the device is modulated by a sine wave of 0.62 V p-p. The ratio of the amplitude of signal on the output to the amplitude of the modulation is the ACPSRR.

TEST CIRCUITS



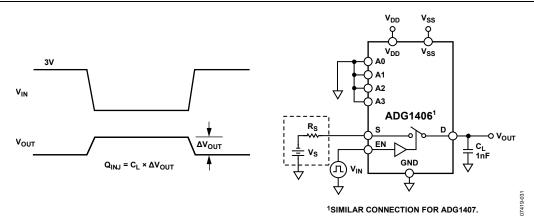


Figure 33. Charge Injection

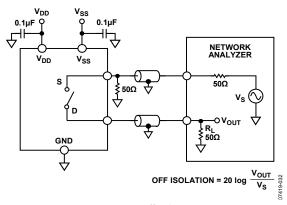
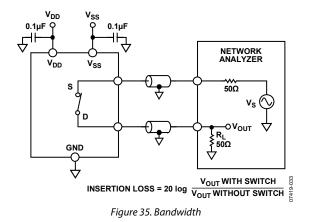


Figure 34. Off Isolation



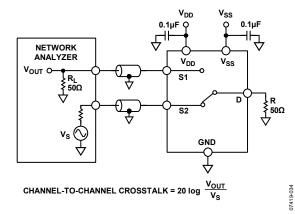


Figure 36. Channel-to-Channel Crosstalk

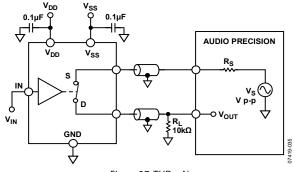
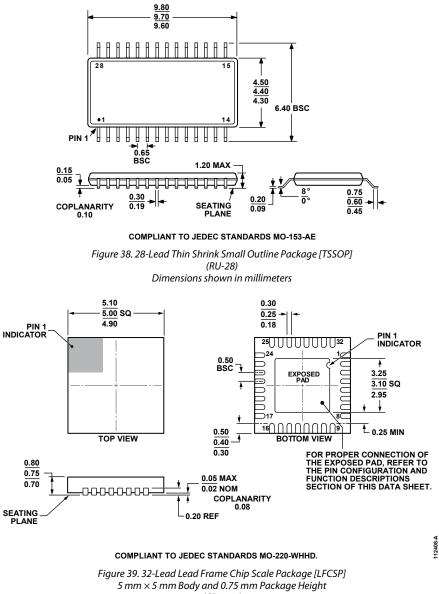


Figure 37. THD + N

OUTLINE DIMENSIONS



(CP-32-7) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Description	Package Option
ADG1406BRUZ	-40°C to +125°C	28-Lead Thin Shrink Small Outline Package [TSSOP]	RU-28
ADG1406BRUZ-REEL7	-40°C to +125°C	28-Lead Thin Shrink Small Outline Package [TSSOP]	RU-28
ADG1406BCPZ-REEL7	-40°C to +125°C	32-Lead Lead Frame Chip Scale Package [LFCSP]	CP-32-7
ADG1407BRUZ	-40°C to +125°C	28-Lead Thin Shrink Small Outline Package [TSSOP]	RU-28
ADG1407BRUZ-REEL7	-40°C to +125°C	28-Lead Thin Shrink Small Outline Package [TSSOP]	RU-28
ADG1407BCPZ-REEL7	-40°C to +125°C	32-Lead Lead Frame Chip Scale Package [LFCSP]	CP-32-7

 1 Z = RoHS Compliant Part.

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